

DATASHEET

EAPLB1921RGBA0



Features

- Unique packaging technology provides better moisture resistance for outdoor use.
- Various options for color mixture including white.
- Good color fidelity and brightness uniformity across the viewing angle.
- RoHS compliant.
- Black body provides better contrast for the display.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

The EAPLB1921RGBA0 SMD LED package provides a perfect solution when users need a clear view of signage display with any size board that is 3 in 1 full color. Smaller pixel pitch between two LEDs creates a high resolution and better contrast with its black body design.

Applications

- Outdoor signage display.
- Outdoor decorating and entertainment design.
- Gaming equipment.
- Indicator and backlighting for all consumer electronics.

Device Selection Guide

Part No.	Chip Materials	Emitted Color
R	AlGaInP	Brilliant Red
G	InGaN	Brilliant Green
В	InGaN	Brilliant Blue

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V _R	5	V
Forward Current	lF	R 20 G 20 B 20	mA
Peak Forward Current (Duty 1/10 @1KHz)	lfp	40	mA
Power Dissipation	Pd	R 48 G 68 B 68	mW
Operating Temperature	T _{opr}	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +90	°C
Soldering Temperature	T _{sol}	Reflow Soldering : 2	60 $^\circ\!\!\mathbb{C}$ for 10 sec

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol		Min.	Тур.	Max.	Unit	Condition
		R	362		793		I⊧=15mA
Luminous Intensity	lv	G	515		1470	mcd	l⊧=8mA
		В	77		220		l⊧=5mA
Viewing Angle	20 _{1/2}			110		deg	I⊧=20mA
		R	615		630		l⊧=15mA
Dominant Wavelength	٨d	G	517		535	nm	l⊧=8mA
		В	465		480		l⊧=5mA
		R		20			I _F =15mA
Spectrum Radiation Bandwidth	Δλ	G		35		nm	I⊧=8mA
		В		25			l⊧=5mA
		R	1.8		2.4		I _F =15mA
Forward Voltage	VF	G	2.4		3.4	V	I⊧=8mA
		В	2.4		3.4		I⊧=5mA
Reverse Current	I _R				10	μA	V _R =5V

Note:

Tolerance of Luminous Intensity: ±10%
 Tolerance of Dominant Wavelength: ±1nm

3. Tolerance of Forward Voltage: ±0.1V

Bin Range of Luminous Intensity

Color	Bin Code	Min.	Max.	Unit	Condition
	RA	362	470	mcd	I _F =15mA
Red	RB	470	610		
	RC	610	793		
	GA	515	670	mcd	I _F =8mA
Green	GB	670	870		
Green	GC	870	1131		
	GD	1131	1470		
Blue	BA	77	100	-	I _F =5mA
	BB	100	130		
Diue	BC	130	169	mcd	
	BD	169	220		

Bin Range of Dominant Wavelength

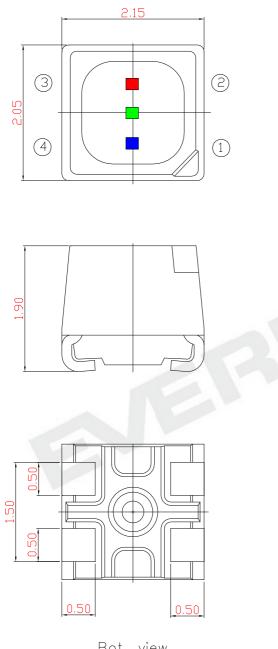
in Range c	of Dominant Wav	elength			
Color	Bin Code	Min.	Max.	Unit	Condition
	R1	615	620	nm	I _F =15mA
Red	R2	620	625		
	R3	625	630		
	G1	517	520	nm	
	G2	520	523		
-	G3	523	526		I⊧ =8mA
Green	G4	526	529		
	G5	529	532		
	G6	532	535		
Blue	B1	465	468	nm	I⊧ =5mA
	B2	468	471		
	B3	471	474		
	B4	474	477		
	B5	477	480		

Note:

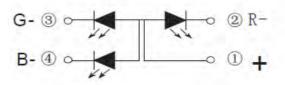
Tolerance of Luminous Intensity: ±10%
 Tolerance of Dominant Wavelength: ±1nm

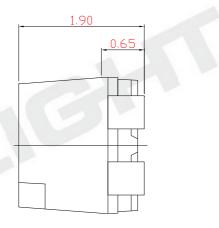


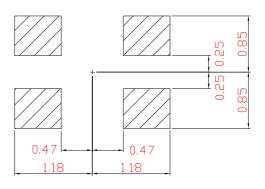
Package Dimension



Bot. view





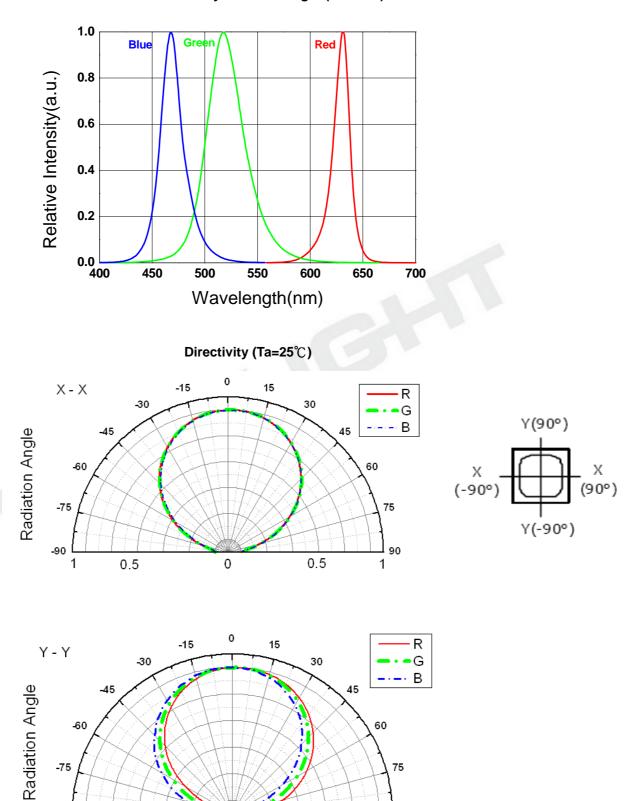


Soldering patterns

Notes:

- 1. Dimensions are in millimeters.
- 2. Tolerances for fixed dimensions are ± 0.1 mm.

Typical Electro-Optical Characteristics Curves



90

1

0.5

Relative Intensity vs. Wavelength (Ta=25°C)

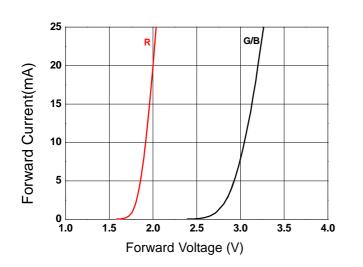
-90

1

0.5

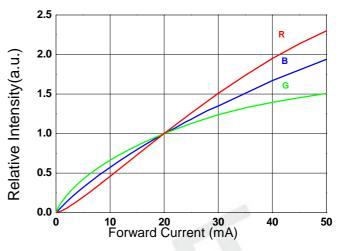
0





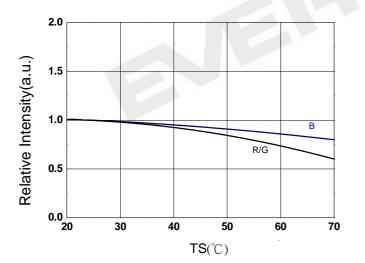
Forward Current vs. Forward Voltage (Ta=25℃)

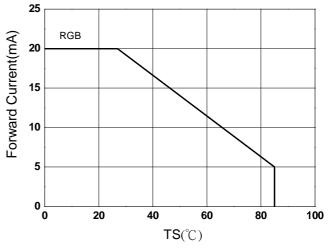
Relative Intensity vs. Forward Current (Ta=25°C)



Relative Intensity vs. Ambient Temp.

Forward Current vs. Ambient Temp.

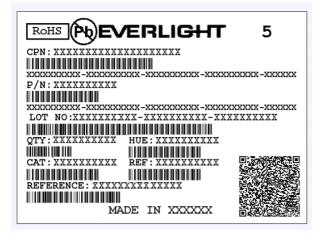






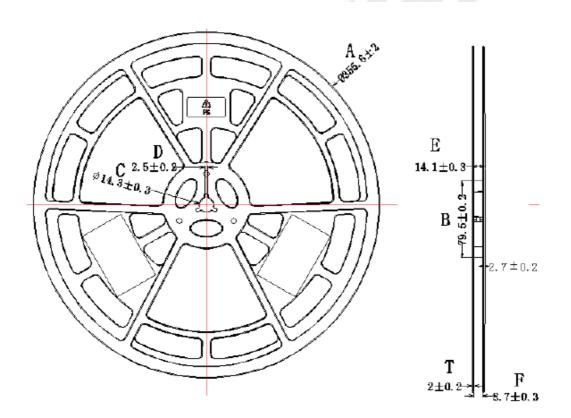
Moisture Resistant Packing Materials

Label Explanation



- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength Rank
- REF: Forward Voltage Rank
- · LOT No: Lot Number

Reel Dimensions

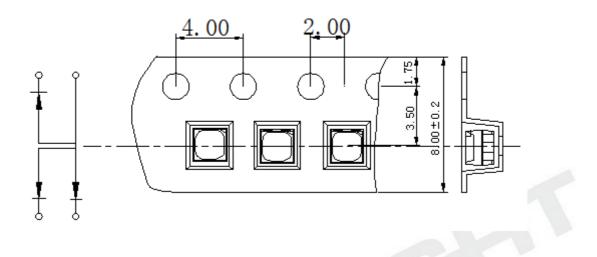


Notes:

- 1. Dimensions are in millimeters.
- 2. Tolerances for fixed dimensions are ± 0.1 mm.

Carrier Tape Dimensions:

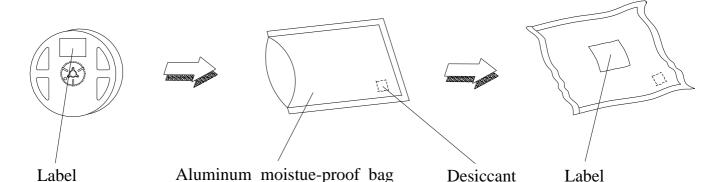
The minimum quantity of packing is 10000 pcs per reel. The rest quantity which could not reach 10000 pcs per reel will goes to 500 pcs per reel.



Notes:

- 1. Dimensions are in millimeters.
- 2. Tolerances for fixed dimensions are ±0.1mm.

Moisture Resistant Packing Process

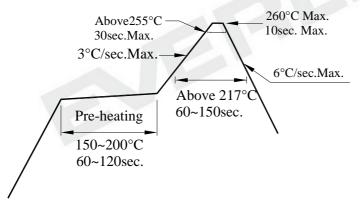


Notes:

- 1. Dimensions are in millimeters.
- 2. Tolerances for fixed dimensions are ± 0.1 mm.

Precautions for Use

- 1. Over-current-proof
 - Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).
- 2. Storage
 - Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to a minimum.
 - Before opening the package, the product should be kept at 30°C or less and humidity less than 60%RH, and be used within 2 months.
 - Before opening the sealed bag, please check whether or not the bag leaked air.
 - If the bag has leaked air, baking is required, baking condition: $(80\pm5)^{\circ}$ for 12 hours.
 - Before soldering the product must be stored under the condition <30°C and <60%RH. Under these conditions the SMD LEDs must be used (subject to reflow) in 12 hours. If the product is under the condition <30°C and <10%RH, the storage time can be extended to 48hours
 - Re-baking is required when exceeding the specified time. Baking condition is as above.
- 3. Soldering Condition
 - Pb -free solder temperature profile



- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.
- 4. ESD (Electrostatic Discharge)
 - The products are sensitive to static electricity or surge voltage. ESD can damage a die and its reliability. When handling the products, the following measures against electrostatic discharge are strongly recommended:
 - Eliminating the charge
 - Grounded wrist strap, ESD footwear, clothes, and floors
 - Grounded workstation equipment and tools

ESD table/shelf mat made of conductive materials

- Proper grounding is required for all devices, equipment, and machinery used in product assembly.
 Surge protection should be considered when designing of commercial products.
- If tools or equipment contain insulating materials such as glass or plastic,

the following measures against electrostatic discharge are strongly recommended:

- Dissipating static charge with conductive materials
- Preventing charge generation with moisture
- Neutralizing the charge with ionizers.
- 5. Directions for use
 - The LEDs should be operated with forward bias. The driving circuit must be designed so that the LEDs are not subjected to forward or reverse voltage while it is off. If reverse voltage is continuously applied to the LEDs, it may cause migration resulting in LED damage.

DISCLAIMER

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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